



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

## **Product Summary**

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
04	0.4Ω @ V <sub>GS</sub> = 10V		0.65A
Q1	30	0.7Ω @ V <sub>GS</sub> = 4.5V	0.52A
00	20	0.9Ω @ V <sub>GS</sub> = -10V	-0.45A
Q2	-30	1.7Ω @ V <sub>GS</sub> = -4.5V	-0.33A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Motor control
- Power-management functions
- DC-DC converters

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

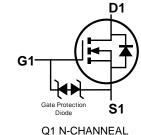
### **Mechanical Data**

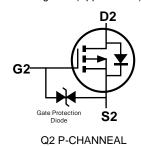
- Package: SOT363
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 63
- Weight: 0.027 grams (Approximate)

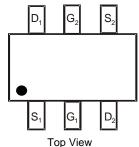




Top View







Pin Out

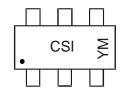
**Ordering Information** (Note 4)

Part Number	Packago	Packing		
Fait Number	Package	Qty.	Carrier	
DMC3400SDW-7	SOT363	3000	Tape & Reel	
DMC3400SDW-13	SOT363	10000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



CSI = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y} = Year$  (ex: L = 2024) M = Month (ex: 9 = September)

Date Code Key

Year	2015		2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	С		L	М	N	Р	R	S	T	U	V	W
				_				A	0	0-1		
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value_Q1	Value_Q2	Unit		
Drain-Source Voltage			$V_{DSS}$	30	-30	V
Gate-Source Voltage			Vgss	±20	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	In In	0.65 0.50	-0.45 -0.36	А
Maximum Continuous Body Diode Forward Curre	ls	0.4	-0.35	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1	l%)		I <sub>DM</sub>	4	-3	Α

# Thermal Characteristics ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.31	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	406	°C/W
Total Power Dissipation (Note 6)		PD	0.39	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	319	°C/W
Thermal Resistance, Junction to Case		R <sub>0</sub> JC	126	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

## Electrical Characteristics - N Channel - Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	- <b>,</b>		71				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 16V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	<u>.</u>					•	
Gate Threshold Voltage	Vgs(TH)	0.8	_	1.6	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Dagger	_	0.2	0.4	Ω	$V_{GS} = 10V, I_D = 0.59A$	
Static Drain-Source On-Resistance	RDS(ON)	_	0.3	0.7	Ω	$V_{GS} = 4.5V, I_{D} = 0.2A$	
Diode Forward Voltage	VsD	_	8.0	1.2	V	Vgs = 0V, Is = 0.23A	
DYNAMIC CHARACTERISTICS (Note 8)	<u>.</u>					•	
Input Capacitance	Ciss	_	55	_	pF	\	
Output Capacitance	Coss	_	8.5	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, - f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	6.5	_	pF	1 = 1.0WH IZ	
Gate Resistance	Rg	_	92	_	Ω	$V_{DS} = V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (VGS = 4.5V)	Qg	_	0.6	_	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	1.4	_	nC	V <sub>DS</sub> = 10V,	
Gate-Source Charge	Q <sub>gs</sub>	_	0.2	_	nC	I <sub>D</sub> = 250mA	
Gate-Drain Charge	Qgd	_	0.1	_	nC	7	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.8	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	3.5	_	ns	Vgs = 10V, Vps = 30V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	25.2	_	ns	$I_D = 100 \text{mA}, R_G = 1\Omega$	
Turn-Off Fall Time	tF	_	18.8	_	ns	1	

Notes:

Device mounted on FR-4 PCB, with minimum recommended pad layout.
 Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



# Electrical Characteristics – P Channel – Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-1	μA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±10	μA	$V_{GS} = \pm 16V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	-1	_	-2.6	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
Static Drain-Source On-Resistance	Descent	_	0.36	0.9	Ω	$V_{GS} = -10V$ , $I_{D} = -0.42A$
Static Drain-Source On-Resistance	RDS(ON)	_	0.57	1.7	Ω	$V_{GS} = -4.5V$ , $I_D = -0.2A$
Diode Forward Voltage	VsD	_	-0.8	-1.2	V	$V_{GS} = 0V$ , $I_{S} = -0.23A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	54	_	pF	151/11/ 01/
Output Capacitance	Coss	_	10	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	8.3	_	pF	I = 1.0IVII IZ
Gate Resistance	Rg	_	240	_	Ω	$V_{DS} = V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	0.6	_	nC	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg	_	1.3	_	nC	\/ 40\/ I- 0.24A
Gate-Source Charge	Qgs	_	0.2	_	nC	$V_{DS} = -10V, I_{D} = -0.24A$
Gate-Drain Charge	Qgd	_	0.2	_	nC	1
Turn-On Delay Time	t <sub>D</sub> (ON)	_	5.7	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	8.8	_	ns	Vgs = -10V, Vdd = -15V,
Turn-Off Delay Time	t <sub>D</sub> (OFF)	_	35	_	ns	$I_D = -0.5A, R_G = 1\Omega$
Turn-Off Fall Time	tF	_	19	_	ns	7

Notes:

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



## Typical Characteristics - N-CHANNEL

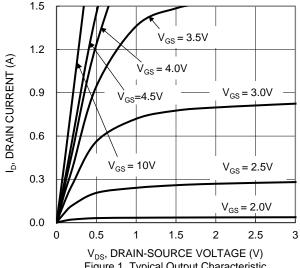
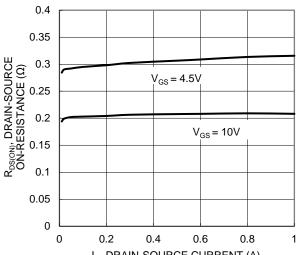


Figure 1. Typical Output Characteristic



I<sub>D</sub>, DRAIN-SOURCE CURRENT (A) Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

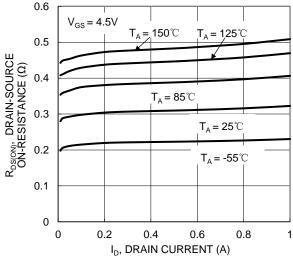


Figure 5. Typical On-Resistance vs. Drain **Current and Temperature** 

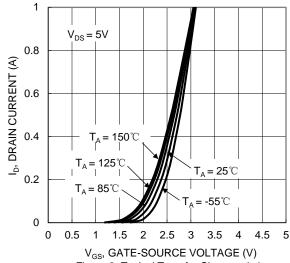
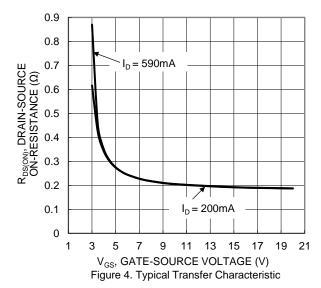


Figure 2. Typical Transfer Characteristic



1.8 R<sub>DS(ON)</sub>, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.6  $V_{GS} = 10V, I_D = 590mA$ 1.4 1.2 1  $V_{GS} = 4.5V, I_D = 200mA$ 8.0 0.6 0 -50 50 75 100 125 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Temperature



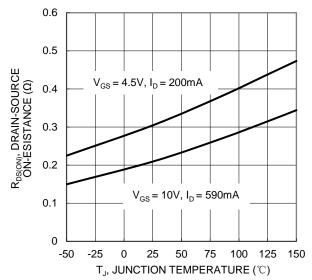


Figure 7. On-Resistance Variation with Temperature

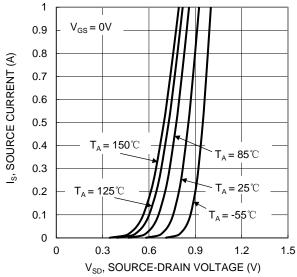
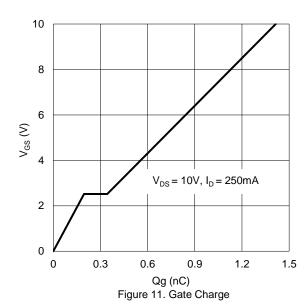


Figure 9. Diode Forward Voltage vs. Current



2  $V_{\text{GS(TH)}},$  GATE THESHOLD VOLTAGE (V) 1.8 1.6  $I_D = 1mA$ 1.4 1.2  $I_{D} = 250 \mu A$ 1 0.8 0.6 0.4 -50 -25 0 25 50 75 100 125 150 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Theshold Variation vs. Junction Temperature

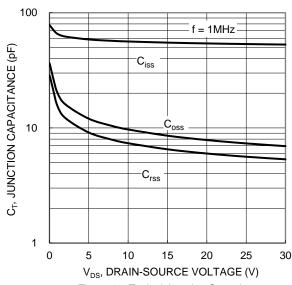
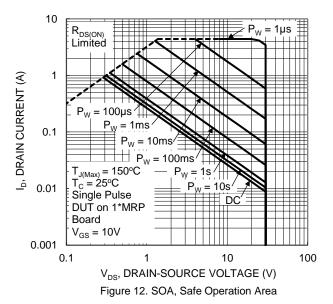
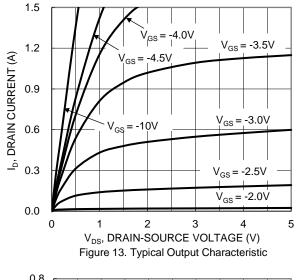


Figure 10. Typical Junction Capacitance





## **Typical Characteristics - P-CHANNEL**



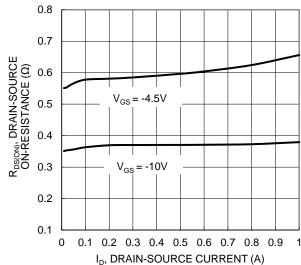
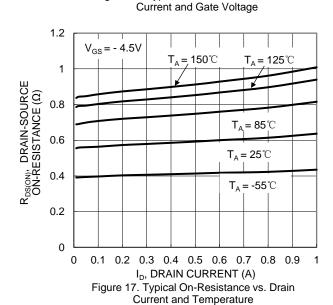
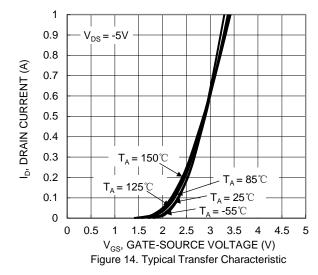
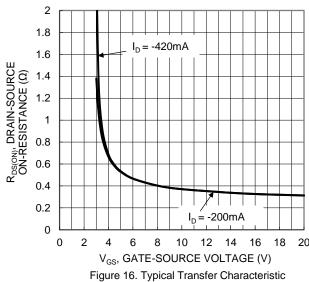


Figure 15. Typical On-Resistance vs. Drain



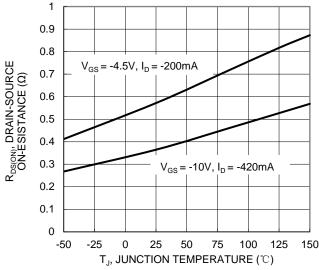


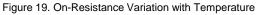


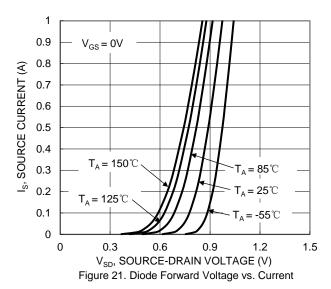
1.8 R<sub>DS(ON)</sub>, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.6 1.4  $V_{GS} = -10V, I_D = -420mA$ 1.2  $V_{GS} = -4.5V, I_{D} = -200mA$ 0.8 0.6 0 25 50 75 100 T<sub>J</sub>, JUNCTION TEMPERATURE (°C) Figure 18. On-Resistance Variation with

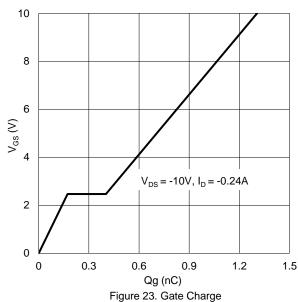
Temperature

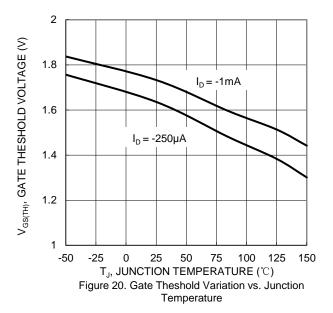


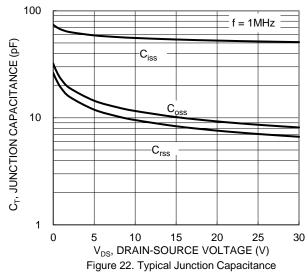


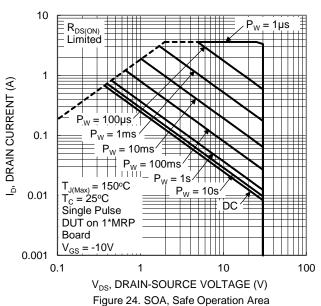




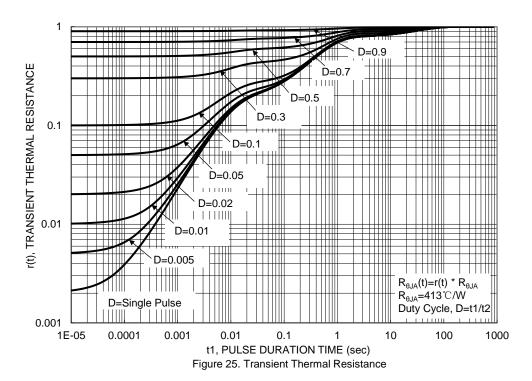










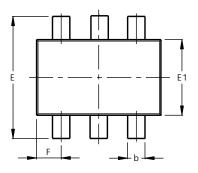


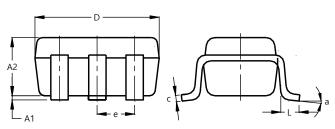


## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT363**



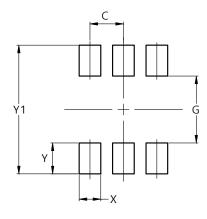


	SOT363							
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
E	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	0	.650 B	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All I	Dimen	sions	in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Υ	0.600
Y1	2 500



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